

JUL 23 2010

Attorney Docket No.: 0400204D

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: **Kinzer, et al.**

Serial No.: 10/613,326

Filed: July 3, 2003

For: **Vertical Conduction Flip-Chip Device
with Bump contacts on Single Surface**

Art Unit: 2811

Examiner: Nadav, Ori

AMENDMENT AND RESPONSE TO OFFICE ACTION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir/Madam:

This is in response to the Office Action dated April 23, 2010 in the above-referenced patent application. Please enter and consider the following amendments and remarks.

The Commissioner is hereby authorized to charge payment of any additional fees associated with this communication, or credit any overpayment to Deposit Account No. 50-0731.

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